



DMT61M8SPS

60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

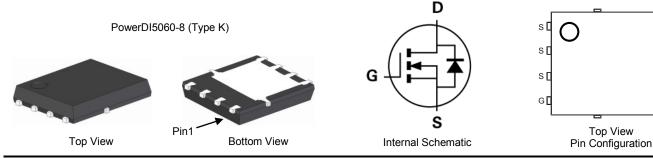
BV _{DSS}	Rds(on) max	I _{D МАХ} T _C = +25°С	
60V	1.6mΩ @ V _{GS} = 10V	205A	

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish—Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Description and Applications

Engine Management Systems

Body Control Electronics DC-DC Converters

load switch.

Notes:

This new generation N-Channel Enhancement Mode MOSFET is

performance. This device is ideal for use in power management and

designed to minimize R_{DS(ON)} yet maintain superior switching

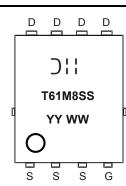
Part Number	Case	Packaging
DMT61M8SPS-13	PowerDI5060-8 (Type K)	2,500 / Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



) || = Manufacturer's Marking T61M8SS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 21 = 2021) WW = Week (01 to 53) Πо

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Maximum Ratings (@ T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	60	V	
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current $M = 40M$ (Mate C)	T _C = +25°C	ID	205	A
Continuous Drain Current, V_{GS} = 10V (Note 6)	T _C = +70°C		160	
Maximum Continuous Body Diode Forward Current (Note 6)	·	Is	205	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	820	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle	I _{SM}	820	А	
Avalanche Current, L = 1mH		IAS	35.8	А
Avalanche Energy, L = 1mH		E _{AS}	640.8	mJ

Thermal Characteristics (@ T_C = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.7	W
Thermal Resistance, Junction to Ambient (Note 5)		R _{θJA}	47	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	139	W
Thermal Resistance, Junction to Case (Note 6)		R _{eJC}	0.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@ T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2		4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	1.1	1.6	mΩ	V _{GS} = 10V, I _D = 30A	
Diode Forward Voltage	V _{SD}	—	0.7	1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)				-	-	-	
Input Capacitance	Ciss	_	8306			V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	C _{oss}	—	2735	_	pF		
Reverse Transfer Capacitance	C _{rss}	—	184	—			
Gate Resistance	Rg	_	3.0	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz	
Total Gate Charge	Qg	_	130.6	_		$V_{DS} = 30V, I_D = 30A,$	
Gate-Source Charge	Q _{gs}	_	30.4	_	nC		
Gate-Drain Charge	Q _{gd}	_	28.1	_		V _{GS} = 10V	
Turn-On Delay Time	t _{D(ON)}	_	11.3	_		V _{DD} = 30V, V _{GS} = 10V, I _D = 30A, R _g = 3Ω	
Turn-On Rise Time	t _R		28.5				
Turn-Off Delay Time	t _{D(OFF)}		86.2		ns		
Turn-Off Fall Time	t _F		47.6			-	
Body Diode Reverse Recovery Time	t _{RR}	_	70.4	—	ns		
Body Diode Reverse Recovery Charge	Q _{RR}	_	127	—	nC	−I _F = 30A, di/dt = 100A/μs	

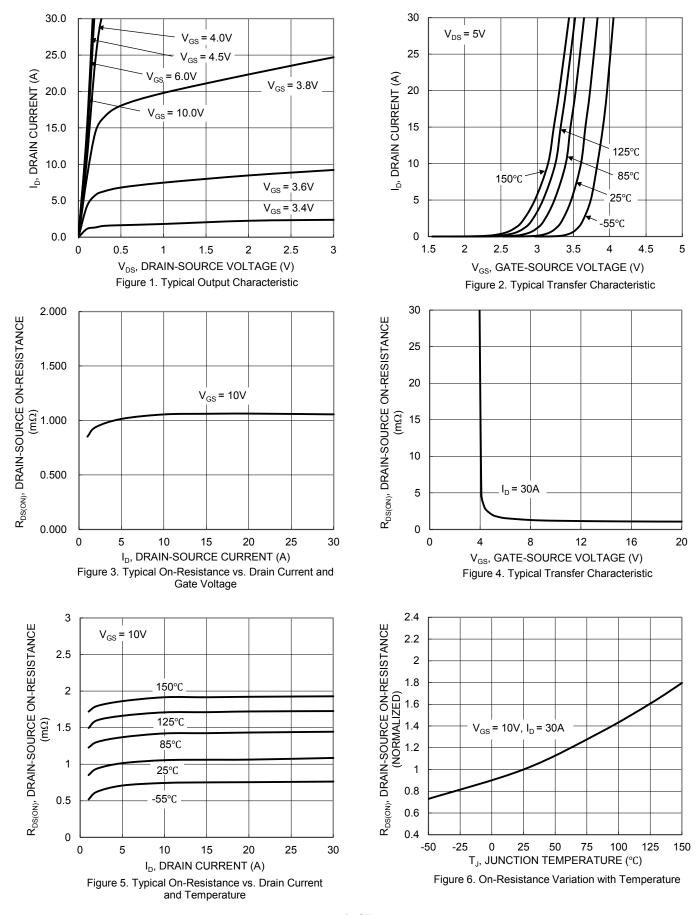
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. Notes:

6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

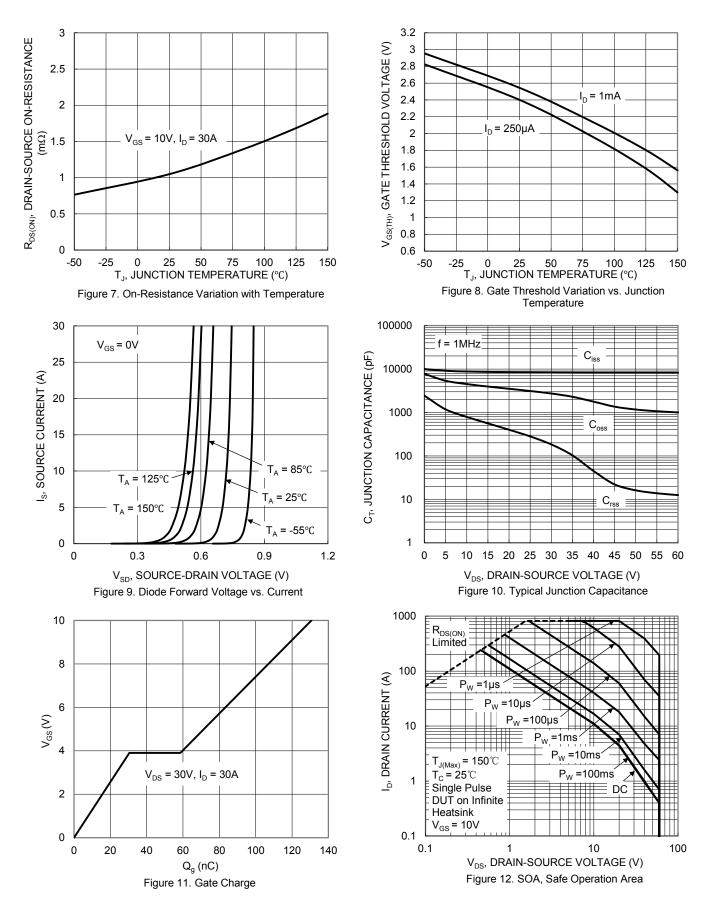


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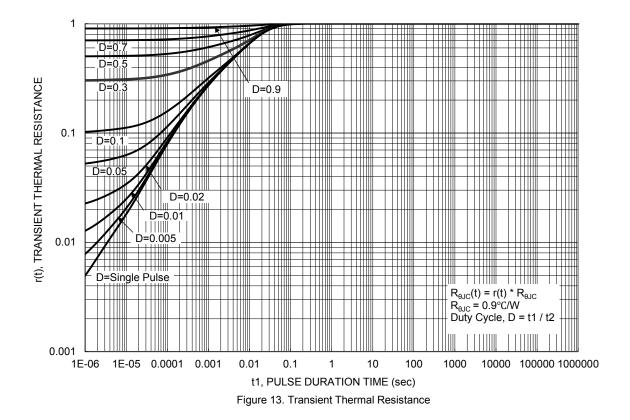


DMT61M8SPS Document number: DS40206 Rev. 8 - 2





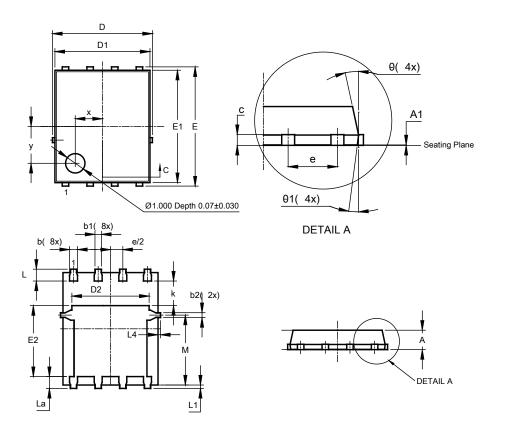






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



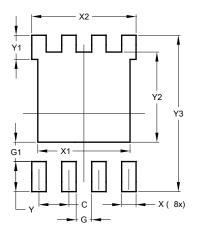
	PowerDI5060-8						
	(Type K) Dim Min Max Typ						
Dim	Min	Min Max					
Α	0.90	1.10	1.00				
A1	0	0.05	0.02				
b	0.33	0.51	0.41				
b1	0.300	0.366	0.333				
b2	0.20	0.35	0.25				
С	0.23	0.33	0.277				
D	5.15 BSC						
D1	4.85	4.95	4.90				
D2	-	-	3.98				
E	6	6.15 BSC					
E1	5.75	5.85	5.80				
E2	3.56	3.725	3.66				
е	1	1.27BSC					
k	-	-	1.27				
L	0.51	0.71	0.61				
La	0.51	0.675	0.61				
L1	0.05	0.20	0.175				
L4	-	-	0.125				
М	3.50	3.71	3.605				
x	-	-	1.400				
У	-	-	1.900				
θ	10°	12°	11°				
θ1	6°	8°	7°				
All							

PowerDI5060-8 (Type K)

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimension	Value (in mm)		
Dimensions			
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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